

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Hideaki Kuwabara et al. Art Unit : 2822  
Serial No. : 10/735,767 Examiner : Kevin Picardat  
Filed : December 16, 2003 Conf. No. : 4086  
Title : SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THE SAME

**MAIL STOP AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**INFORMATION DISCLOSURE STATEMENT**

Applicants request consideration of the references listed on the attached PTO-1449 form. Under 37 C.F.R. § 1.98 (a)(2)(ii), only copies of foreign patent documents and/or non-patent literature are enclosed. Copies of any listed U.S. patents or U.S. patent application publications can be provided upon request. A copy of a communication from a foreign patent office in a counterpart application is also enclosed. In particular, the communication is an International Search Report for the European Patent Office Application No. EP 03029012.6, dated August 22, 2006 (5 pages).

Each item of information in this statement, with the exception of references "AB," "AC" and "AD" (*i*) was cited in a communication from a foreign patent office in a counterpart foreign application, the communication being dated August 22, 2006, which is not more than three months prior to the filing of this statement, and (*ii*) was not first cited in any communication from a foreign patent office in a counterpart application which was more than three months prior to the filing date of this statement. Reference "AB" is an English-language document corresponding to reference "AM"; reference "AC" is an English-language document corresponding to reference "AL"; and reference "AD" is an English-language document corresponding to reference "AK." References "AB," "AC" and "AD" are cited in accordance with MPEP 609(III)(B)(5).

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Attorney's Docket No.: 12732-189001 / US6847

No fee is believed due at this time. Please apply any charges or credits to Deposit  
Account No. 06-1050.

Respectfully submitted,

Date: September 14, 2006

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Substitute Form PTO-1449 (Modified)		U.S. Department of Commerce Patent and Trademark Office	Attorney's Docket No. 12732-189001	Application No. 10/735,767
<b>Information Disclosure Statement by Applicant</b> (Use several sheets if necessary)  (37 CFR §1.98(b))		Applicant Hideaki Kuwabara et al.		
		Filing Date December 16, 2003	Group Art Unit 2822	

<b>U.S. Patent Documents</b>							
Examiner Initial	Desig. ID	Document Number	Publication Date	Patentee	Class	Subclass	Filing Date If Appropriate
	AA	2001/0040298	11/15/2001	Baba			01/04/2001
	AB	2002/0100941	08/01/2002	Yonehara			01/31/2002
	AC	2003/0057423	03/27/2003	Shimoda			02/24/1999
	AD	6,503,778	01/07/2003	Yamauchi			09/27/2000
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						

<b>Foreign Patent Documents or Published Foreign Patent Applications</b>							
Examiner Initial	Desig. ID	Document Number	Publication Date	Country or Patent Office	Class	Subclass	Translation
							Yes No
	AK	DE-10047963	03/29/2001	Germany			ABS
	AL	EP-1017100	07/05/2000	Europe			In English
	AM	EP-1229582	08/07/2002	Europe			In English
	AN	JP-11-020360	01/26/1999	Japan			ABS
	AO						

<b>Other Documents (include Author, Title, Date, and Place of Publication)</b>		
Examiner Initial	Desig. ID	Document
	AP	European Search Report dated August 22, 2006 for European Patent Office Application No.: 03029012.6, 5 pages
	AQ	Zhang, X. et al., "Thermal Conductivity and Diffusivity of Free-Standing Silicon Nitride Thin Films"; <i>Review of Scientific Instruments</i> , Vol. 66, No. 2, Part 1; pp. 1115-1120; 02/1995
	AR	
	AS	

Examiner Signature	Date Considered
EXAMINER: Initials citation considered. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.	